

LOCKHEED MARTI

23 April 2010

Dr. Juan Ordonez and Dr. Chiang Shih Florida State University Department of Mechanical Engineering FAMU-FSU College of Engineering 2525 Pottsdamer Street Tallahassee, FL 32310

ATTN: FSU-OTEC Group#14 (Adam Choby, Simon Chong, Matthew Cocking, Mike Collins) Subject: Thank You Letter and Winning Project Notification

Dear Dr Ordonez, Dr Shih and Florida State University OTEC Sr Project Members:

Congratulations! As part of the OTEC senior design project and our evaluation and assessment of all teams, we have determined that Florida State University is the winner of the OTEC heat exchanger and system design project. All of the project teams submitted very good design solutions to the heat exchanger design and OTEC system. The evaluations were difficult during this highly competitive project, and we would again like to congratulate you as the winners of the OTEC design project competition. Further details from ORNL will follow for the internship and NELHA and Makai trip in June.

On behalf of Oak Ridge National Laboratory (ORNL) and Lockheed Martin (LM), we would like to thank you for your participation in the Graphite Foam Heat Exchanger Senior Design Project Competition. Your efforts during this project will help further heat exchanger development for the Ocean Thermal Energy Conversion (OTEC) project.

Your creativity, insights, innovative designs and concepts were all outstanding. Thanks to your efforts and participation we can now explore additional concepts for heat exchanger design.

We wish you luck in your future endeavors and careers and have no doubt that you will all be successful. Again, many thanks for your efforts, accomplishments and commitment to this project.

Sincerely,

Yames

James W. Klett ORNL

Scott

Scott M. Maurer LM MS2

Xelvin

Kelvin D. Quarles LM MS2